

PATENT  
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Masanori KOIZUMI

Serial No: Not assigned

Filed: October 15, 2003

For: Semiconductor Device and Method of Fabrication  
Thereof, Optical Module and Method of Fabrication  
Thereof, Circuit Board, and Electronic Instrument

Art Unit: Not assigned

Examiner: Not assigned

**TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT**

Mail Stop PATENT APPLICATION  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

The information disclosure statement submitted herewith is being filed concurrently with the subject application [37 C.F.R. § 1.97(b)] and contains no items of information cited in any communication from a foreign patent office in a counterpart foreign application [37 C.F.R. § 1.97(e)(1)].

If it should be determined that for any reason either an insufficient or excessive fee has been paid, please charge any insufficiency or credit any overpayment necessary to ensure consideration of the information disclosure statement for the above-identified application to Deposit Account No. 50-1314. A copy of this paper is enclosed.

Respectfully submitted,

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